

SURFACE MOUNT

RF Transformer

TC8-1-10LN+

50Ω 2 to 500 MHz

FEATURES

- Wideband, 2 to 500 MHz
- Good Return Loss
- Plastic Base with Leads
- Aqueous Washable



Generic photo used for illustration purposes only

CASE STYLE: AT224-1A

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Push-Pull Amplifier
- Impedance Matching

ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (Secondary/Primary)			8		Ohms
Frequency Range		2		500	MHz
Insertion Loss ¹	2-500		3.0		dB
	5-400		2.0		
	10-100		1.0		
Phase Unbalance (Deg.)				5	Deg
Amplitude Unbalance (dB)				0.7	dB
Return Loss	5-400	9			dB
	2-500		9		

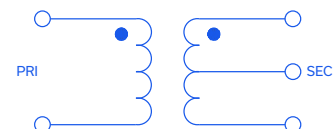
1. Insertion Loss is referenced to mid-band loss, 0.8 dB typ.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +100°C
RF Power	0.25 W
DC DWV	500 mA
DC Current (Primary)	0 mA
DC Current (Secondary)	150 mA ²
Insulation Resistance Pri to Sec	1M Ohms

2. Applied through center tap, equal current to secondary dot & secondary.
Permanent damage may occur if any of these limits are exceeded.

CONFIG. A





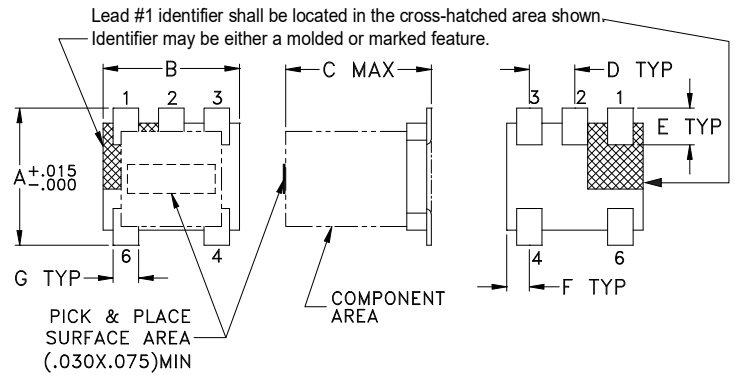
PIN CONNECTIONS

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	3
SECONDARY	1
SECONDARY CT	2

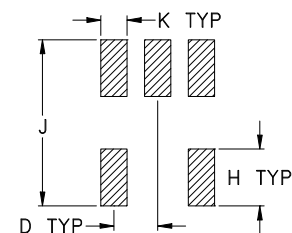
PRODUCT MARKING: N/A

DEMOBOARD MCL P/N: TB-TC8-1-10LN+

OUTLINE DRAWING

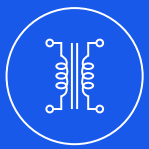


PCB Land Pattern

Suggested Layout,
Tolerance to be within $\pm .002$ OUTLINE DIMENSIONS (Inch
mm)

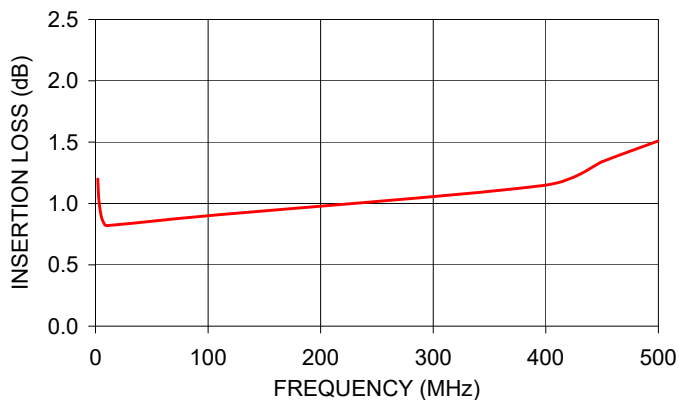
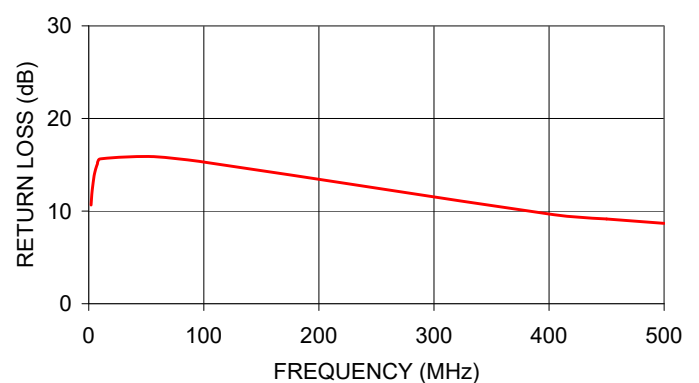
A	B	C	D	E	F
.150	.150	.160	.050	.040	.025
3.81	3.81	4.06	1.27	1.02	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.15	

TAPE & REEL INFORMATION: F17



TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
2.00	1.20	10.65
3.00	1.03	12.20
5.00	0.90	14.01
7.50	0.84	15.09
10.00	0.82	15.64
55.00	0.86	15.88
100.00	0.90	15.29
400.00	1.15	9.68
450.00	1.34	9.15
500.00	1.51	8.67

TC8-1-10LN+
INSERTION LOSSTC8-1-10LN+
INPUT RETURN LOSS

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

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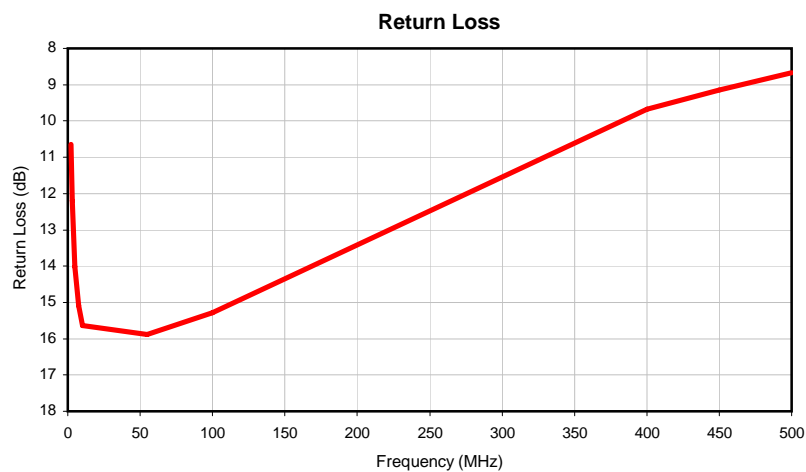
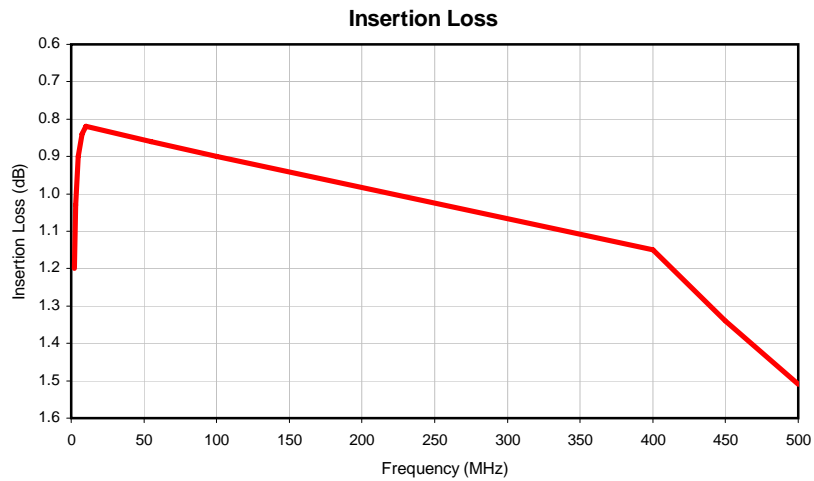


P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 • Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site
 The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

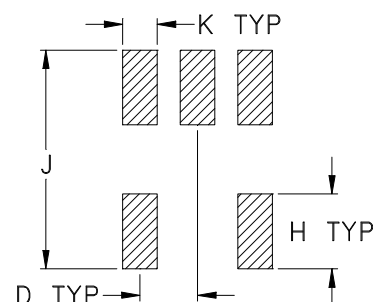
IF/RF MICROWAVE COMPONENTS

REV. X1
TC8-1-10LN+
4/19/2011
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Typical Performance Data



AT

AT224-1A

Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAMS
AT224-1A	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. + .01; 3 Pl. + .005

1. Case material: Plastic.
2. Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
3. Lead #1 identifier shall be located in the cross-hatched area shown.
Identifier may be either a molded or marked feature.

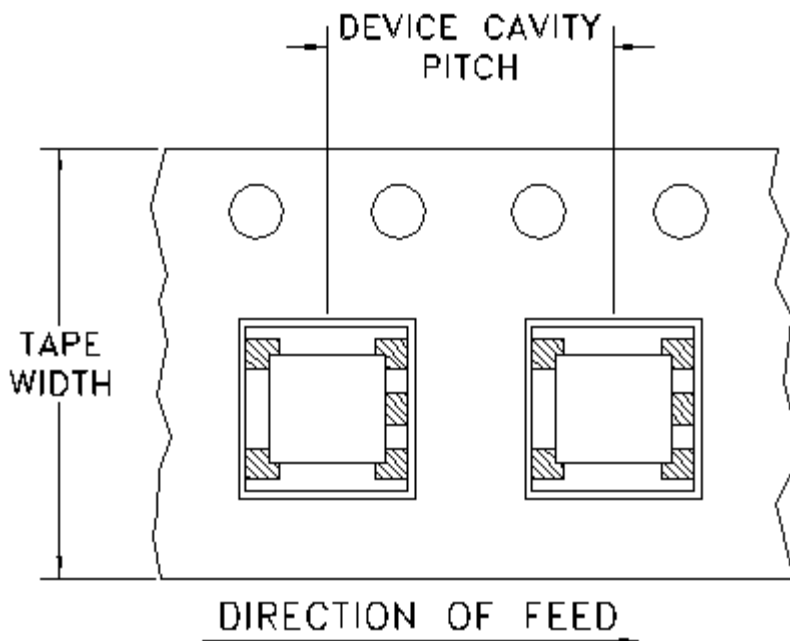


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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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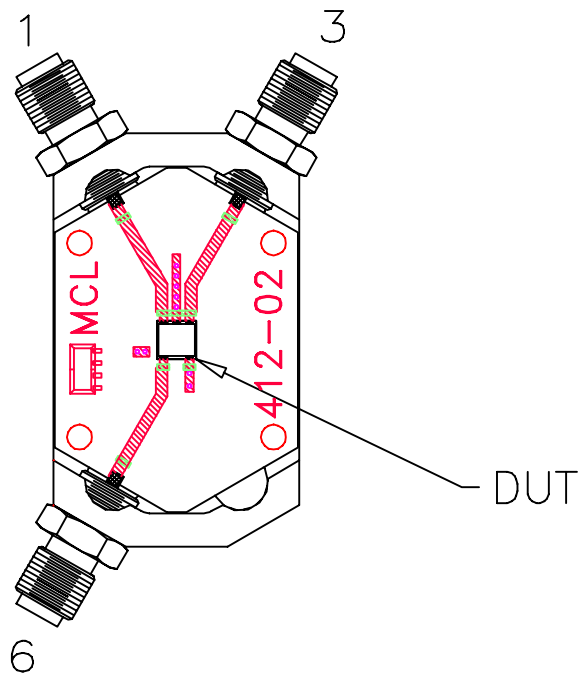


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RF/IF MICROWAVE COMPONENTS

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT




TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215